

N-CHANNEL ENHANCEMENT MODE POWER MOSFET

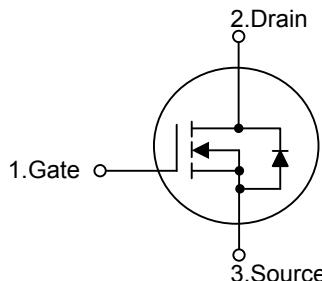
■ DESCRIPTION

The UTC **UTT3205** uses advanced technology to provide excellent $R_{DS(ON)}$, fast switching, low gate charge, and excellent efficiency. This device is suitable for all commercial-industrial applications at power dissipation levels to approximately 50 watts.

■ FEATURES

- * $R_{DS(ON)} < 20\text{m}\Omega$ @ $V_{GS} = 10\text{V}$
- * Ultra Low Gate Charge (146nC max)
- * Low Reverse Transfer Capacitance ($C_{RSS} = \text{typ. } 211\text{ pF}$)
- * Fast Switching Capability
- * Avalanche Energy Specified
- * Improved dv/dt Capability, High Ruggedness

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
UTT3205L-TA3-T	UTT3205G-TA3-T	TO-220	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

UTT3205L-TA3-T   	(1) Packing Type (2) Package Type (3) Lead Free	(1) T: Tube (2) TA3: TO-220 (3) G: Halogen Free, L: Lead Free
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■ ABSOLUTE MAXIMUM RATINGS ($T_J=25^\circ\text{C}$, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Gate-Source Voltage		V_{GS}	± 20	V
Drain Current	Continuous ($V_{GS}=10\text{V}$)	I_D	110	A
	Pulsed (Note 2)	I_{DM}	390	
Avalanche Current (Note 2)		I_{AR}	62	A
Avalanche Energy	Repetitive (Note 2)	E_{AR}	20	mJ
	Single Pulsed (Note 3)	E_{AS}	450	
Power Dissipation ($T_c=25^\circ\text{C}$)		P_D	200	W
Junction Temperature		T_J	+150	$^\circ\text{C}$
Storage Temperature		T_{STG}	-55 ~ +150	$^\circ\text{C}$

Note: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged.

Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Pulse width limited by $T_{J(\text{MAX})}$

3. $T_J=25^\circ\text{C}$, $L=138\mu\text{H}$, $R_G=25\Omega$, $I_{AS}=62\text{A}$

■ THERMAL DATA

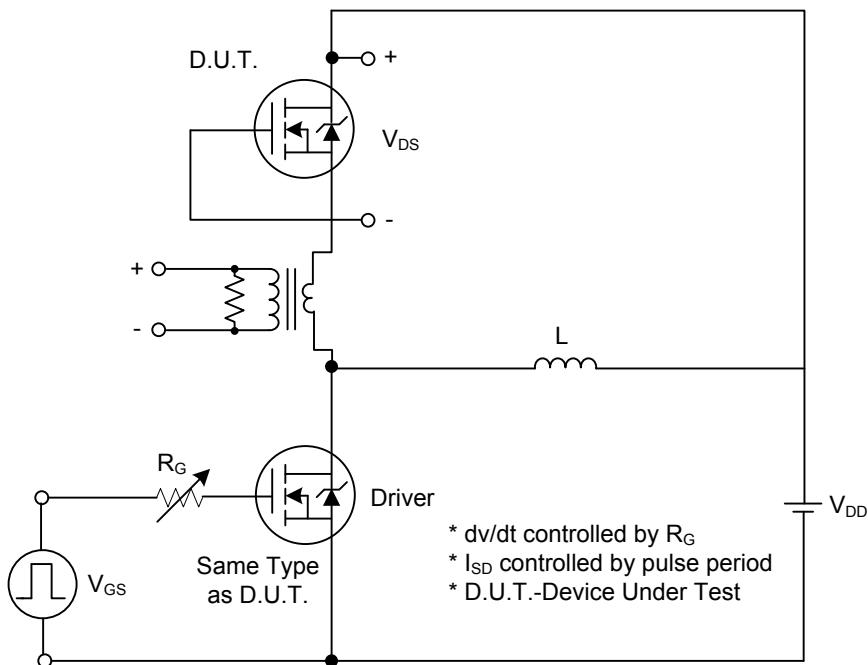
PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ_{JA}	62	$^\circ\text{C}/\text{W}$
Junction to Case		θ_{JC}	0.75	$^\circ\text{C}/\text{W}$

■ ELECTRICAL CHARACTERISTICS ($T_J=25^\circ\text{C}$, unless otherwise specified)

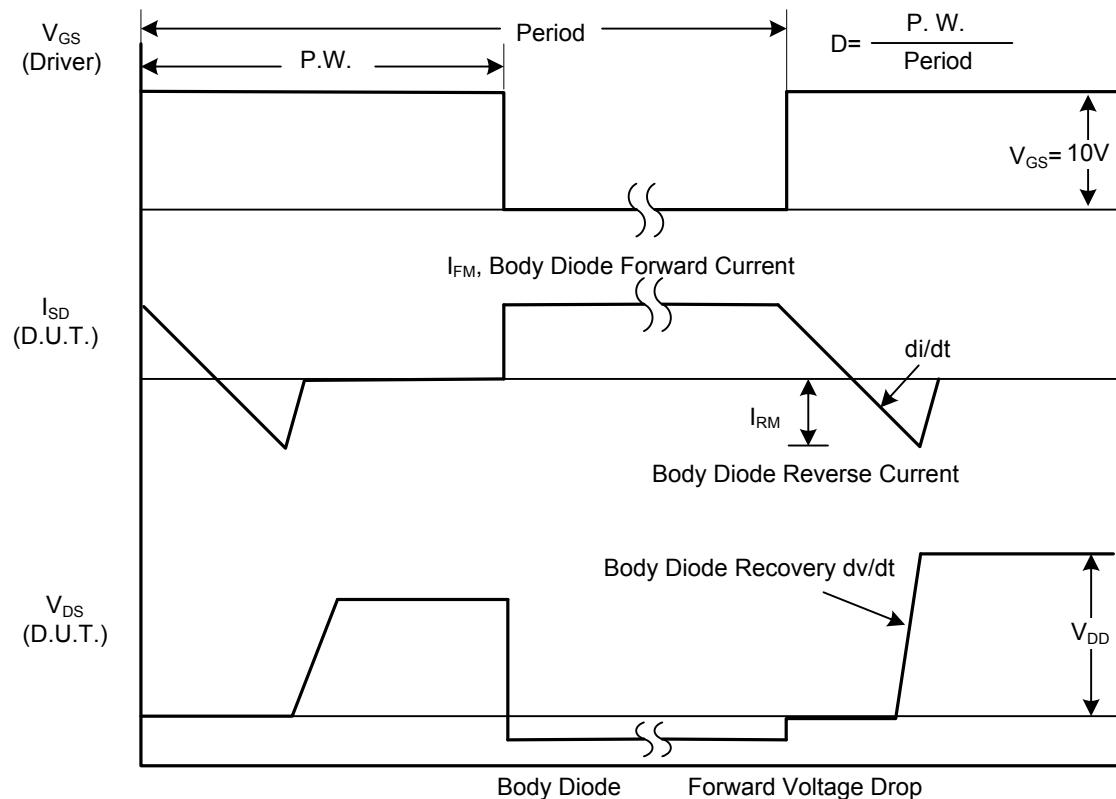
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	$V_{GS}=0\text{V}$, $I_D=250\mu\text{A}$	55			V
Drain-Source Leakage Current		I_{DSS}	$V_{DS}=55\text{V}$, $V_{GS}=0\text{V}$			25	μA
Gate- Source Leakage Current	Forward	I_{GSS}	$V_{GS}=+20\text{V}$, $V_{DS}=0\text{V}$			+100	nA
	Reverse		$V_{GS}=-20\text{V}$, $V_{DS}=0\text{V}$			-100	nA
Breakdown Voltage Temperature Coefficient		$\Delta BV_{DSS}/\Delta T_J$	Reference to 25°C , $I_D=1\text{mA}$		0.057		$\text{V}/^\circ\text{C}$
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(\text{TH})}$	$V_{DS}=V_{GS}$, $I_D=250\mu\text{A}$	1.4		3.0	V
Static Drain-Source On-Resistance (Note)		$R_{DS(\text{ON})}$	$V_{GS}=10\text{V}$, $I_D=62\text{A}$			20	$\text{m}\Omega$
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	$V_{DS}=25\text{V}$, $V_{GS}=0\text{V}$, $f=1\text{MHz}$		3247		pF
Output Capacitance		C_{OSS}			781		pF
Reverse Transfer Capacitance		C_{RSS}			211		pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	$V_{DS}=44\text{V}$, $I_D=62\text{A}$, $V_{GS}=10\text{V}$			146	nC
Gate Source Charge		Q_{GS}				35	nC
Gate Drain Charge		Q_{GD}				54	nC
Turn-ON Delay Time		$t_{D(\text{ON})}$			14		ns
Turn-ON Rise Time		t_R	$V_{DD}=28\text{V}$, $I_D=62\text{A}$, $R_G=4.5\Omega$, $V_{GS}=10\text{V}$ (Note)		101		ns
Turn-OFF Delay Time		$t_{D(\text{OFF})}$			50		ns
Turn-OFF Fall-Time		t_F			65		ns
Internal Drain Inductance		L_D			4.5		nH
Internal Source Inductance		L_S			7.5		nH
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Diode Forward Voltage		V_{SD}	$I_S=62\text{A}$, $V_{GS}=0\text{V}$			1.3	V
Maximum Continuous Drain-Source Diode Forward Current		I_S				110	A
Maximum Pulsed Drain-Source Diode Forward Current		I_{SM}				390	A

Note: Pulse width $\leq 400\mu\text{s}$; duty cycle $\leq 2\%$.

■ TEST CIRCUITS AND WAVEFORMS

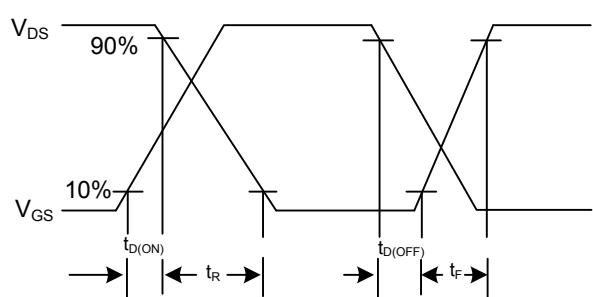
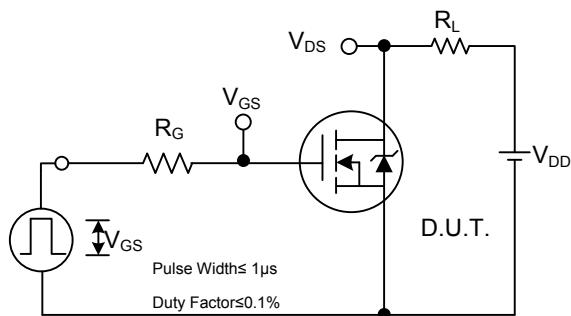


Peak Diode Recovery dv/dt Test Circuit



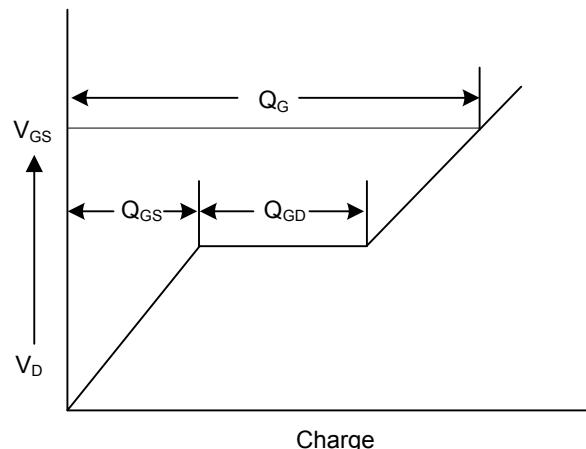
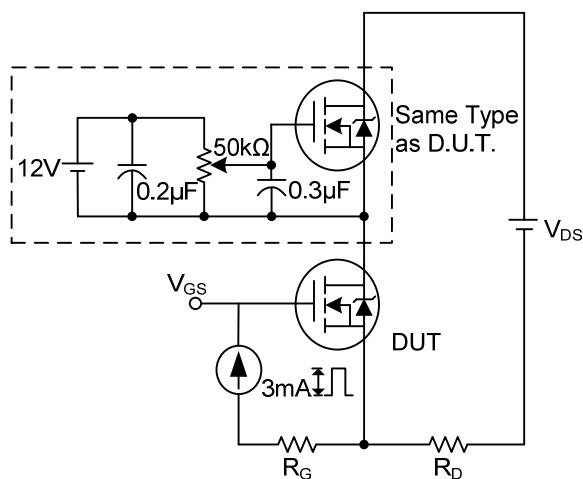
Peak Diode Recovery dv/dt Waveforms

■ TEST CIRCUITS AND WAVEFORMS (Cont.)



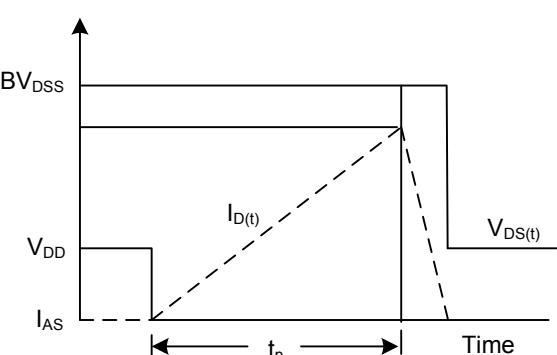
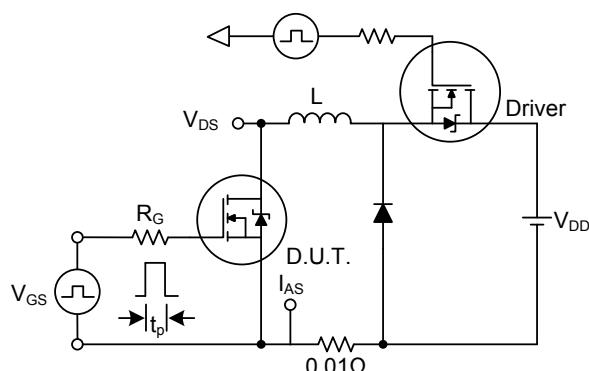
Switching Test Circuit

Switching Waveforms



Gate Charge Test Circuit

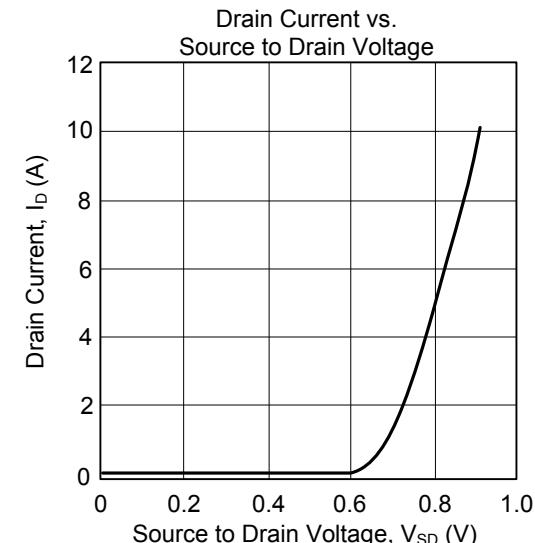
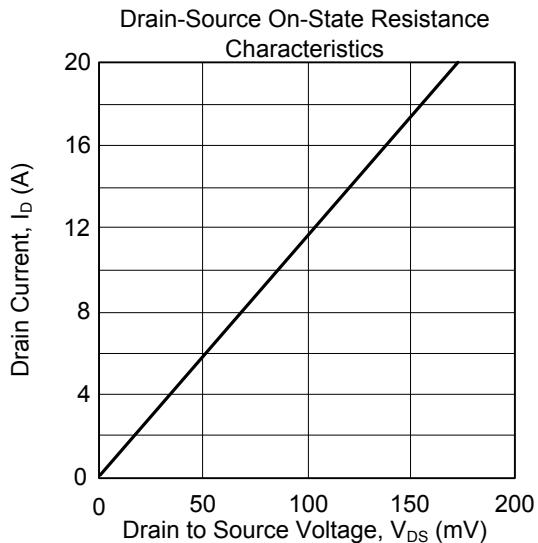
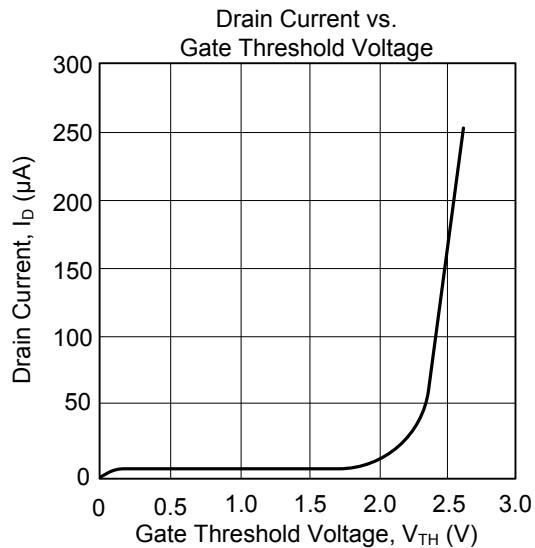
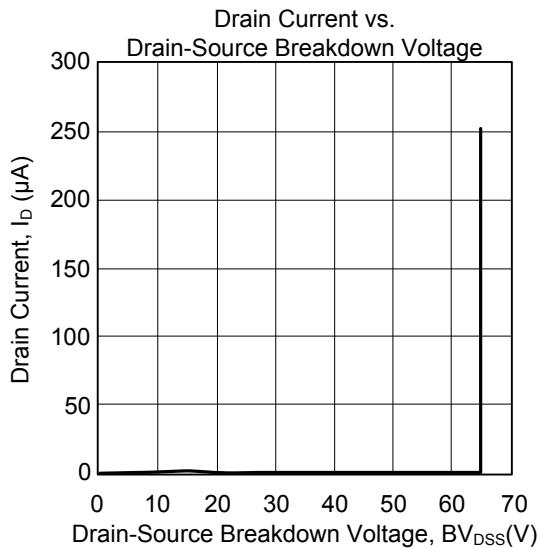
Gate Charge Waveform



Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS



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